

KAMAYA OHM

Spec. No.: RMCH-1K-2121011(2)
Date: 2021. 5. 3

Preliminary Data sheet

Title: FIXED THICK FILM CHIP RESISTORS:

RECTANGULAR TYPE & HIGH POWER

Style: RMCH06

AEC-Q200 qualified

RoHS COMPLIANCE ITEM
Halogen and Antimony Free

Note: •Stock conditions

Temperature: $+5^{\circ}\text{C} \sim +35^{\circ}\text{C}$ Relative humidity: $25\% \sim 75\%$

The period of guarantee: Within 2 year from shipment by the company.

Solderability shall be satisfied.

- Product specification contained in this data sheet are subject to change at any time without notice
- •If you have any questions or a Purchasing Specification for any quality Agreement is necessary, please contact our sales staff.



Hokkaido Research Center Approval by: T. Sannomiya Drawing by: M. Shibuya

Drawing No: RMCH-1K-2121011

Title: FIXED THICK FILM CHIP RESISTORS; RECTANGULAR TYPE & HIGH POWER

RMCH06 Page: 1/7

1. Scope

1.1 This data sheet covers the detail requirements for fixed thick film chip resistors; rectangular type & high power, style of RMCH06

1.2 Applicable documents

JIS C 5201-1: 2011, IEC60115-1: 2008, AEC-Q200 Rev.D

1.3 For Automotive Grade

- AEC-Q200 qualified (Grade 0)

2. Classification

Type designation shall be the following form.

(Example)

1)	RMCH	06	_	123	J	PA
	1	2	3	4	5	6
	Style	9				
2)	RMCH	06		JP		TP
,	1	2		4		6
	Style	9				

1 Fixed thick film chip resistors; rectangular type & high power

2 Rated dissipation and / or dimension

3 Temperature coefficient of resistance

K	±100×10 ⁻⁶ / °C	
–(Dash)	Standard	

Style

4 Rated resistance

123	E24 Series, 3 digit,	Ex. 123> 12kΩ,
1000	E96 Series, 4 digit,	Ex. 1000>100Ω
		1022> 10.2kΩ
JP	Chip jumper	

5 Tolerance on rated resistance

D	±0.5%
F	±1%
J	±5%

6 Packaging form 1. Scope

····9···9 ·····						
В	Bulk (loose package)					
PA	Press pocket taping					

Title: FIXED THICK FILM CHIP RESISTORS; RECTANGULAR TYPE & HIGH POWER

RMCH06 Page: 2/7

3. Rating

3.1 The ratings shall be in accordance with Table–1.

Table-1(1)

	IADIC I(I)						
Style	Rated dissipation (W)		re coefficient of ce (10 ⁻⁶ / °C)	Rated resistance range (Ω)	Preferred number series for resistors	Tolerance on rated resistance	
			±200	10~1M		D(±0.5%)	
			±200	10~10M	E24, 96	F(±1%)	
RMCH06	0.063	Standard	+350~-100	1~9.76		Γ(±170)	
			±200	10~10M	E24	I(± 5 0()	
			+350~-100	1~9.1	C24	J(±5%)	

Style	Limiting element voltage (V)	Isolation voltage (V)	Category temperature range (°C)
RMCH06	25	50	<i>–</i> 55∼+155

3.2 Chip Jumper

Table-1(2)

		. ab.c .(<u>-</u>)	
Ct do	Chip jumper	Resistance value of	Rated current of chip jumper
Style	symbol	chip jumper	(A)
RMCH06	JP	50mΩmax.	1

3.3 Derating

The derated values of dissipation (or current rating in case of chip jumper) at temperature in excess of 70 °C shall be as indicated by the following curve.

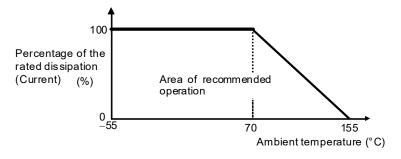


Figure-1 Derating curve

3.4 Rated voltage

d. c. or a. c. r. m. s. voltage calculated from the square root of the product of the rated resistance and the rated dissipation.

$$E : Rated voltage (V)$$

$$E = \bigvee P \cdot R$$

$$P : Rated dissipation (W)$$

$$R : Rated resistance (\Omega)$$

Limiting element voltage can only be applied to resistors when the resistance value is equal to or higher than the critical resistance value.

At high value of resistance, the rated voltage may not be applicable.

FIXED THICK FILM CHIP RESISTORS; RECTANGULAR TYPE & HIGH POWER

Page: 3/7

4. Packaging form

The standard packaging form shall be in accordance with Table-2.

Table-2

Symbol	Pad	Standard packaging quantity / units		
В	Bulk (loose package)	Bulk (loose package)		
PA	Press pocket taping (paper taping)	8mm width, 2mm pitches	15,000 pcs.	

5. Dimensions

5.1 The resistor shall be of the design and physical dimensions in accordance with Figure-2 and Table-3.

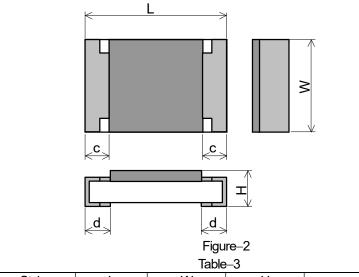


		Table	⊢ 3		Unit: mm	1
Style	L	W	Н	С	d	
RMCH06	0.6±0.03	0.3±0.03	0.23±0.03	0.1±0.05	0.15±0.05	

5.2 Net weight (Reference)

Style	Net weight(mg)	
RMCH06	0.16	

6. Marking

The Rated resistance of RMCH06 should not be marked.

KAMAYA OHM

Drawing No: RMCH-1K-2121011

FIXED THICK FILM CHIP RESISTORS; RECTANGULAR TYPE & HIGH POWER

Page: 4/7

7. Performance

7.1 The standard condition for tests shall be in accordance with Sub-clause 4.2, JIS C 5201–1: 1998.

7.2 The performance shall be satisfied in Table-4.

Table-4(1)

No.	Test items	Condition of test	Performance requirements
1	High temperature exposure	MIL-STD-202 Method 108	Resistor:
	AEC Q200 - No.3	Ambient temperature:155±2°C,	Δ R/R: Within ±(3%+0.1 Ω)
		Condition: Without load,	Chip jumper: $50 \text{m}\Omega$ max.
		Duration: 1000 +48 h	No visible damage
		Interval measurements: 250 h and 500 h	
2	Temperature cycling	JESD22 Method JA-104	Resistor:
	AEC Q200 - No.4	Temperature: -55±3°C / 125±2°C,	Δ R/R: Within ±(3%+0.1 Ω)
		Dwell time: 30min maximum at each temp.	Chip jumper: $50 \text{m}\Omega$ max.
		Transition time: 1 min. max.	No visible damage
		Number of cycles: 1000 cycles.	_
		Interval measurements: 250 cy and 500 cy	
3	Bias humidity	MIL-STD-202 Method 103	Resistor:
	AEC Q200 – No.7	Condition: 85°C & 85% R.H.	Δ R/R: Within \pm (3%+0.1 Ω)
		Test power: 10% of rated power shall be	Chip jumper: $50 \text{m}\Omega$ max.
		applied for continuously.	No visible damage
		Duration: 1,000 ⁺⁴⁸ ₀ h	
		Interval measurements: 250 h and 500 h	
4	Operational life	MIL-STD-202 Method 108	Resistor:
	AEC Q200 – No.8	Ambient temperature: 125±2°C	Δ R/R: Within \pm (3%+0.1 Ω)
		The applied voltage shall be the voltage to be	Chip jumper: $50 \text{m}\Omega$ max.
		calculated at 35% of rated dissipation or the	No visible damage
		limiting element voltage whichever is the	
		smaller.	
		Condition: The voltage shall be applied for continuously.	
		1	
		Duration: 1000 +48 h	
		Interval measurements: 250 h and 500 h	
5	External Visual	MIL-STD-883 Method 2009	Inspect device construction, marking
	AEC Q200 – No.9		and workmanship.
6	Dimensions	JESD22 Method JB-100	As in Table–3
	AEC Q200 – No.10	MIL OTD COOM IL 1045	
7	Resistance to Solvents	MIL-STD-202 Method 215	Resistor: $\Delta R/R$: Within $\pm (1\%+0.05\Omega)$
	AEC Q200 – No.12	Solvent: 2-propanol at 25°C	Chip jumper: $50 \text{m}\Omega$ max.
		Immersion time: 3 min	No visible damage
		Brush: 10 times brushing	
	Machaniael Charle	Immersion and brush cycle: 3cycle	D 11 AD/D M/H 1 1/40/ 0.05 (2)
8	Mechanical Shock	MIL-STD-202 Method 213	Resistor: Δ R/R: Within \pm (1%+0.05 Ω)
	AEC Q200 – No.13	Waveform: half sine, Peak value100G,	Chip jumper: $50 \text{m}\Omega$ max.
		Normal duration 6ms	No visible damage
		Condition: XX'YY'ZZ', 10times each	
		CONTRIBUTION AND THE ZEA, TOURNES EACH	

FIXED THICK FILM CHIP RESISTORS; RECTANGULAR TYPE & HIGH POWER

Page: 5/7

Table 4(2)

18DIE-4(Z)			
No	Test items	Condition of test	Performance requirements
9	Vibration	MIL-STD-202 Method 204	Resistor: Δ R/R: Within \pm (1%+0.05 Ω)
	AEC Q200 – No.14	Peak acceleration and Sweep time: 5 g's for 20	Chip jumper: $50 \text{m}\Omega$ max.
		min , Frequency 10Hz to 2000Hz,	No visible damage
		Condition: 12 cycles each of 3 orientations	
10	Resistance to soldering heat	MIL-STD-202 Method 210	Resistor: Δ R/R: Within \pm (1%+0.05 Ω)
	AEC Q200 - No.15	Solder bath temp: 260±5°C	Chip jumper: $50m\Omega$ max.
		Immersed time: 10±1s	No visible damage
11	ESD test	AEC-Q200-002	Resistor: Δ R/R: Within \pm (5%+0.1 Ω)
	AEC Q200 – No.17	Human body model, 2 Kohm, 150 pF,	Chip jumper: $50 \text{m}\Omega$ max.
		Test voltage: 500V	No visible damage
12	Solderability	J-STD-002	The surface of terminal immersed shall
	AEC Q200 - No.18	a) Bake the sample for 155 °C dwell time 4h /	be min. of 95% covered with a new
		solder dipping 235°C/ 5s.	coating of solder.
		Solder: Sn96.5-Ag3-Cu0.5	-
		b) Category 3, Solder dipping 215°C/ 5s.	
		Solder: Sn63Pb37	
		c) Category 3, Solder dipping 260°C/7s.	
13	Electrical Characterization	1. D.C. Resistance	1. The resistance value shall
	AEC Q200 - No.19	Temperature Coefficient of Resistance	correspond with the rated resistance
		-55 °C / +20°C	taking into account the specified
		+20 °C / +155°C	tolerance.
			2. As in Table–1
14	Flammability	UL-94	V-0 or V-1 are acceptable
	AEC Q200 – No.20		
15	Bending strength	AEC-Q200-005	Resistor: Δ R/R: Within \pm (1%+0.05 Ω)
	AEC Q200 – No.21	Bending value2mm	Chip jumper: $50 \text{m}\Omega$ max.
		Holding time: 60sec.	No visible damage
16	Adhesion	AEC-Q200-006	Resistor: $\Delta R/R$: Within $\pm (1\%+0.05\Omega)$
	AEC Q200 – No.22	Pressurizing force: 3N	Chip jumper: $50 \text{m}\Omega$ max.
		Test time: 60±1s.	No visible damage
17	Flame retardance	AEC-Q200-001	The following FAILURE CRITERIA
	AEC Q200 – No.24	Test conditions: 9VDC to 32VDC Each 1h	does not occur.
		This test applies to rated voltages of 32V and	FAILURE CRITERIA
		above.	- Electrically open
			a) A flame over 3.0 seconds duration
			b) An explosion
			c) A temperature above 350°C
			sustained for over 10 s
		•	

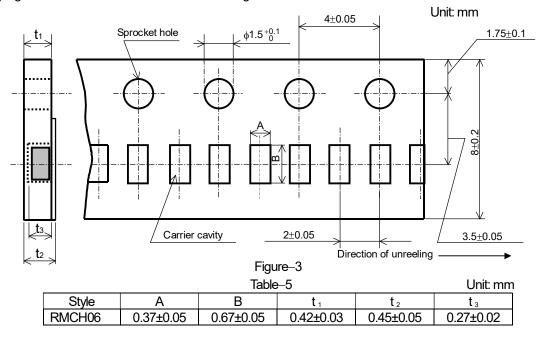
Title: FIXED THICK FILM CHIP RESISTORS; RECTANGULAR TYPE & HIGH POWER

RMCH06 Page: 6/7

8. Taping

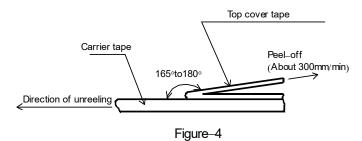
- 8.1 Applicable documents JIS C 0806-3: 2014, EIAJ ET-7200C: 2010
- 8.2 Taping dimensions
- 8.2.1 Press pocket taping (Paper taping, 8mm width, 2mm pitches)

Taping dimensions shall be in accordance with Figure-3 and Table-5.



- 1). The cover tapes shall not cover the sprocket holes.
- 2). Tapes in adjacent layers shall not stick together in the packing.
- 3). Components shall not stick to the carrier tape or to the cover tape.
- 4). Pitch tolerance over any 10 pitches ±0.2mm.
- 5). The peel strength of the top cover tape shall be with in 0.1N to 0.5N on the test method as shown in the following Figure-4.
- 6). When the tape is bent with the minimum radius for 25 mm, the tape shall not be damaged and the components shall maintain their position and orientation in the tape.
- 7). In no case shall there be two or more consecutive components missing.

 The maximum number of missing components shall be one or 0.1%, whichever is greater.
- 8). The resistors shall be faced to upward at the over coating side in the carrier cavity.



Page:

Drawing No:

7/7

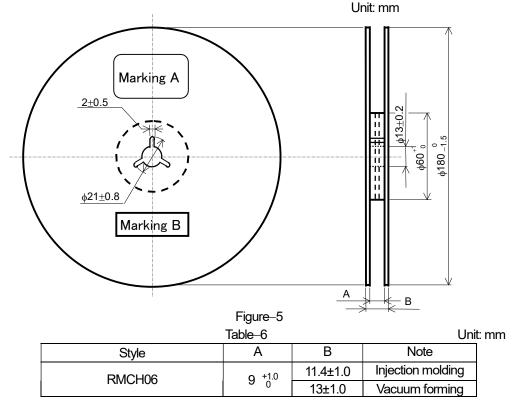
Title: FIXED THICK FILM CHIP RESISTORS; RECTANGULAR TYPE & HIGH POWER

RMCH06

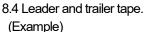
8.3 Reel dimension

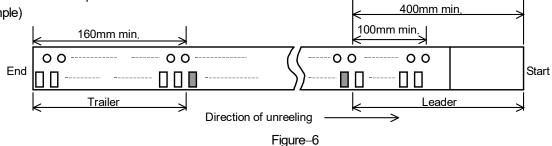
Reel dimensions shall be in accordance with the following Figure–5 and Table–6.

Plastic reel (Based on EIAJ ET-7200C)



Note: Marking label shall be marked on a place of Marking A or two place of marking A and B.





9. Marking on package

The label of a minimum package shall be legibly marked with follows.

9.1 Marking A

(1) Classification

(Style, Temperature coefficient of resistance, Rated resistance, Tolerance on rated resistance, Packaging form)

(2) Quantity (3) Lot number (4) Manufacturer's name or trade mark (5) Others

9.2 Marking B (KAMAYA Control label)

X-ON Electronics

Largest Supplier of Electrical and Electronic Components

Click to view similar products for Thick Film Resistors - SMD category:

Click to view products by Kamaya manufacturer:

Other Similar products are found below:

CR-05FL7--150R CR-05FL7--698K CR-12JP4--680R M55342K08B46E4SWL M55342K08B62J0SUL M55342K08B6J20SWB

MCR01MZPF1202 MCR01MZPF1601 MCR01MZPF1800 MCR01MZPF6201 MCR01MZPF9102 MCR01MZPJ113 MCR01MZPJ121

MCR01MZPJ125 MCR01MZPJ751 MCR03EZHJ103 MCR03EZPFX2004 MCR03EZPJ270 MCR03EZPJ821 MCR10EZPF1102

RC1005F1152CS RC1005F1372CS RC1005F2052CS RC1005F471CS RC1005F4751CS RC1005F5621CS RC1005F6041CS

RC1005J121CS RC1005J122CS RC1005J180CS RC1005J181CS RC1005J202CS RC1005J391CS RC1005J512CS RC1005J683CS

RC1005J823CS RC1608F333CS RC1608F5110CS RC1608J121CS RC2012F2493CS RC2012F2740CS RC2012J105CS RC2012J470CS

RC2012J561CS RC2012J8R2CS RC3216F100CS RC3216F272CS RC3225F30R1CS RCP0603W100RGED RCWP1100100KFKS3